

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P <sub>PP</sub>	20	W	8/20μs, See Figure 3
Peak Pulse Current	I <sub>PP</sub>	2	A	8/20μs, See Figure 3
ESD Protection – Contact Discharge	V <sub>ESD_CONTACT</sub>	±14	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V <sub>ESD_AIR</sub>	±15	kV	IEC 61000-4-2 Standard
ESD Protection – Human Body Model	V <sub>ESD_HBM</sub>	±10	kV	MIL-STD-883; Class 3B

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P <sub>D</sub>	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	V <sub>RWM</sub>	—	—	5	V	—
Channel Leakage Current (Note 6)	I <sub>RM</sub>	—	1	100	nA	V <sub>RWM</sub> = 5V
Snapback Voltage	V <sub>SNP</sub>	5.3	—	—	V	—
Clamping Voltage, Positive Transients	V <sub>CL</sub>	—	—	11.5	V	I <sub>PP</sub> = 0.5A, t <sub>p</sub> = 8/20μs
		—	—	12.8		I <sub>PP</sub> = 1A, t <sub>p</sub> = 8/20μs
Breakdown Voltage	V <sub>BR</sub>	6	—	10	V	I <sub>R</sub> = 1mA
Differential Resistance	R <sub>DYN</sub>	—	2.0	—	Ω	TLP, 10A, t <sub>p</sub> = 100ns
Channel Input Capacitance	C <sub>IN</sub>	4	5.3	6	pF	V <sub>R</sub> = 0V, f = 1MHz

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's website at <http://www.diodes.com/package-outlines.html>.  
 6. Short duration pulse test used to minimize self-heating effect.

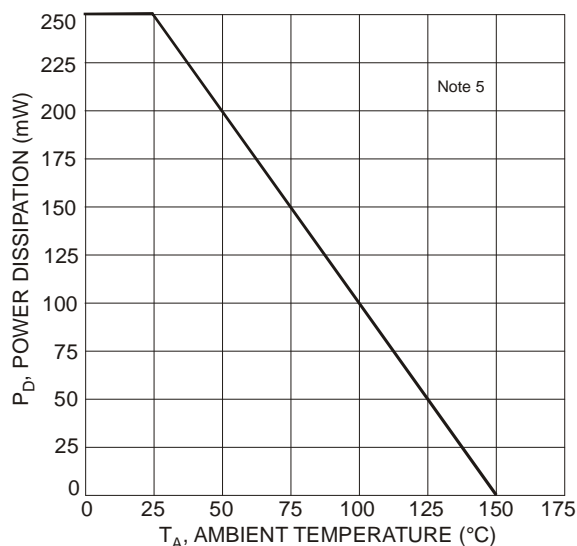


Figure 1 Power Derating Curve

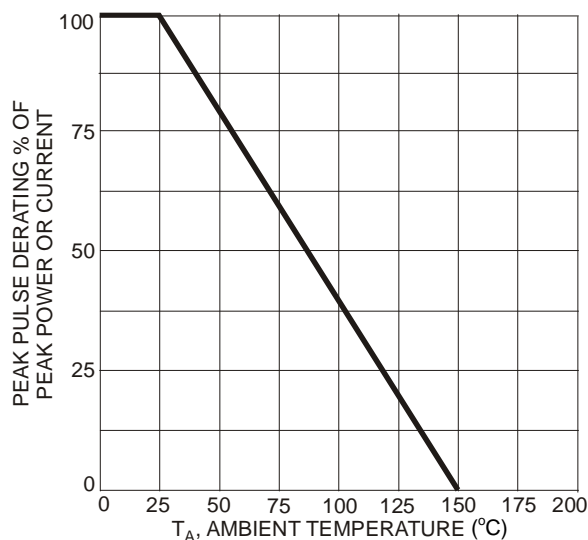
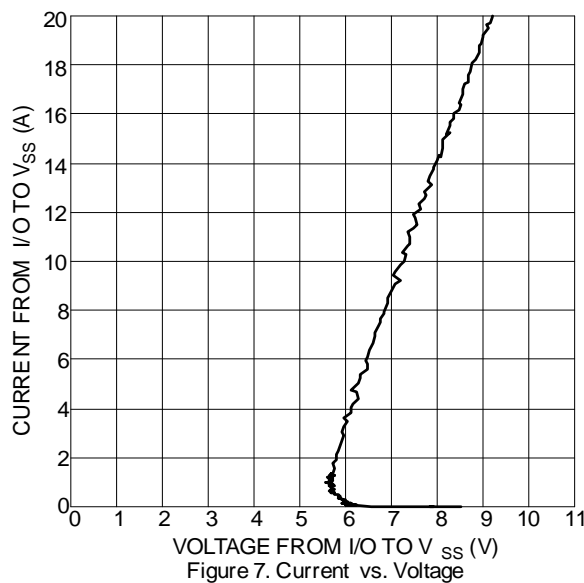
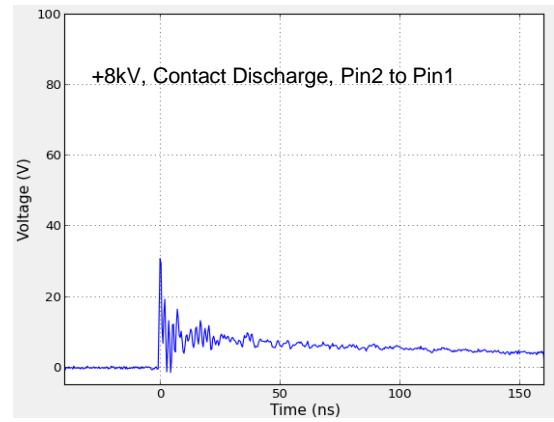
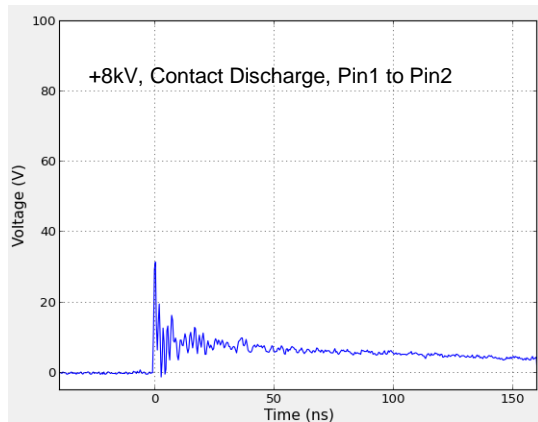
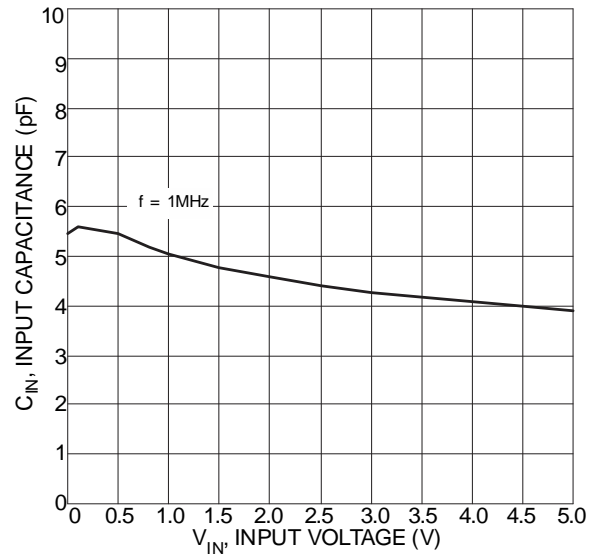
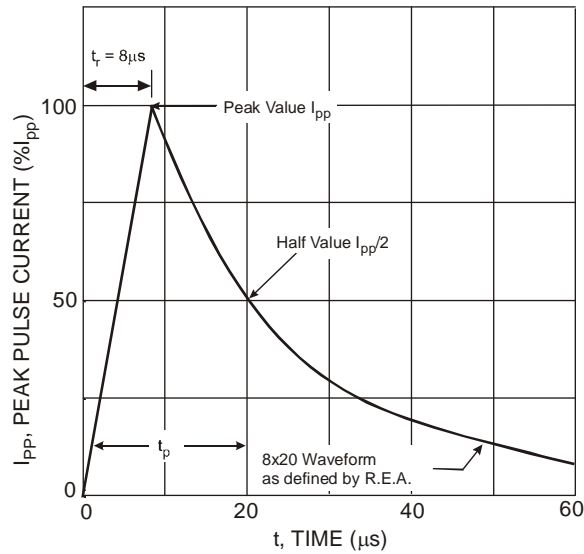


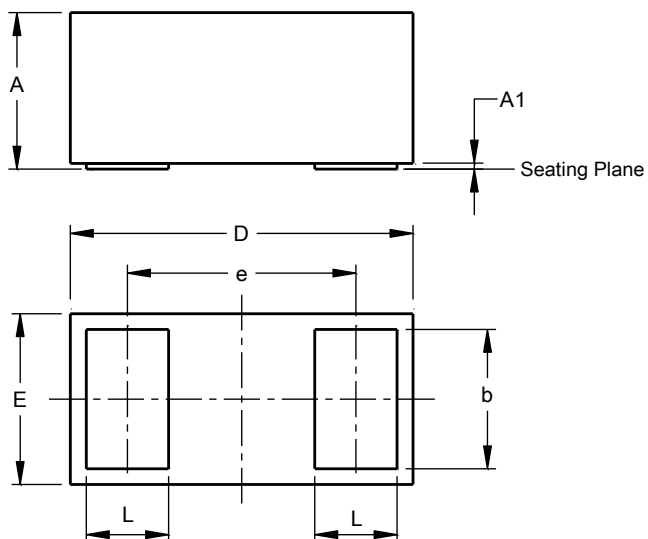
Figure 2 Pulse Derating Curve



## Package Outline Dimensions (Note 7)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**X2-DSN0603-2**



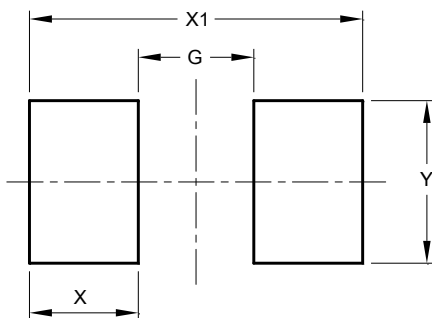
X2-DSN0603-2			
Dim	Min	Max	Typ
A	0.280	0.320	0.300
A1	0.00	0.020	0.010
b	0.220	0.260	0.240
D	0.575	0.625	0.600
E	0.275	0.325	0.300
e	-	-	0.400
L	0.120	0.160	0.140
All Dimensions in mm			

Note 7: Device side walls are electrically active bare silicon. Avoid contact of solder or flux on the side walls during the PCB assembly process.

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**X2-DSN0603-2**



Dimensions	Value (in mm)
G	0.206
X	0.194
Y	0.291
X1	0.594

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